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## Exhibition Report

SEMICON West 2010, one of the world's largest semiconductor exhibition, was held at Moscone Center in San Francisco from July 13<sup>th</sup> to 15<sup>th</sup>, 2010. This event attracts many exhibitors and visitors from around the world.

We would like to introduce to you some of our applications for the cutting-edge semiconductor equipment parts in which we exhibited at the booth this year.

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### TSV Process

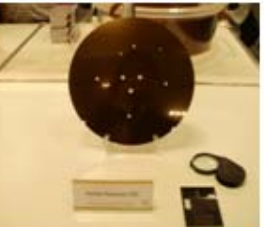
- Thin-Wafer Handling ESC
- Thin-Film Heater ESC  
(Round Type, Square Type)



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### Low Particle

- Damage-Free ESC
- Low Particle PI Vacuum Chuck
- Particle Reduction ESC



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### Next-Generation Equipment

- 450 mm Thermal Spray ESC
- Multi-Layer Coated ESC



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### Green Application

- Green Inverter
- Passive Chuck  
(Non-Voltage "Gecko" chuck)



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We were delighted to see all of you and appreciate your time in visiting our booth at SEMICON West 2010. We are confident that our technology will be advantageous to your company's success.

If you have any inquires relating to our products, please feel free to contact us below.

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